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#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product Status	Obsolete
Core Processor	M8C
Core Size	8-Bit
Speed	24MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	LVD, POR, PWM, WDT
Number of I/O	16
Program Memory Size	2KB (2K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.25V
Data Converters	A/D 2x14b; D/A 1x9b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	20-DIP (0.300", 7.62mm)
Supplier Device Package	20-DIP
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c22213-24pi

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

processor. The CPU utilizes an interrupt controller with 10 vectors, to simplify programming of real time embedded events. Program execution is timed and protected using the included Sleep and Watch Dog Timers (WDT).

Memory encompasses 2 KB of Flash for program storage, 256 bytes of SRAM for data storage, and up to 2 KB of EEPROM emulated using the Flash. Program Flash utilizes four protection levels on blocks of 64 bytes, allowing customized software IP protection.

The PSoC device incorporates flexible internal clock generators, including a 24 MHz IMO (internal main oscillator) accurate to 2.5% over temperature and voltage. The 24 MHz IMO can also be doubled to 48 MHz for use by the digital system. A low power 32 kHz ILO (internal low speed oscillator) is provided for the Sleep timer and WDT. If crystal accuracy is desired, the ECO (32.768 kHz external crystal oscillator) is available for use as a Real Time Clock (RTC) and can optionally generate a crystal-accurate 24 MHz system clock using a PLL. The clocks, together with programmable clock dividers (as a System Resource), provide the flexibility to integrate almost any timing requirement into the PSoC device.

PSoC GPIOs provide connection to the CPU, digital and analog resources of the device. Each pin's drive mode may be selected from eight options, allowing great flexibility in external interfacing. Every pin also has the capability to generate a system interrupt on high level, low level, and change from last read.

### The Digital System

The Digital System is composed of 4 digital PSoC blocks. Each block is an 8-bit resource that can be used alone or combined with other blocks to form 8, 16, 24, and 32-bit peripherals, which are called user module references.



**Digital System Block Diagram** 

Digital peripheral configurations include those listed below.

- PWMs (8 to 32 bit)
- PWMs with Dead band (8 to 32 bit)
- Counters (8 to 32 bit)
- Timers (8 to 32 bit)
- UART 8-bit with selectable parity (up to 1)
- SPI master and slave (up to 1)
- I2C slave and master (1 available as a System Resource)
- Cyclical Redundancy Checker/Generator (8 to 32 bit)
- IrDA (up to 1)
- Pseudo Random Sequence Generators (8 to 32 bit)

The digital blocks can be connected to any GPIO through a series of global buses that can route any signal to any pin. The buses also allow for signal multiplexing and for performing logic operations. This configurability frees your designs from the constraints of a fixed peripheral controller.

Digital blocks are provided in rows of four, where the number of blocks varies by PSoC device family. This allows you the optimum choice of system resources for your application. Family resources are shown in the table titled "PSoC Device Characteristics" on page 3.

### The Analog System

The Analog System is composed of 3 configurable blocks, each comprised of an opamp circuit allowing the creation of complex analog signal flows. Analog peripherals are very flexible and can be customized to support specific application requirements. Some of the more common PSoC analog functions (most available as user modules) are listed below.

- Analog-to-digital converters (one with 6- to 14-bit resolution, selectable as Incremental, Delta Sigma, and SAR)
- Filters (two pole band-pass, low-pass, and notch)
- Amplifiers (one with selectable gain to 48x)
- Comparators (one with 16 selectable thresholds)
- DACs (one with 6- to 9-bit resolution)
- Multiplying DACs (one with 6- to 9-bit resolution)
- High current output drivers (one with 30 mA drive as a Core Resource)
- 1.3V reference (as a System Resource)
- Many other topologies possible

## **Getting Started**

The quickest path to understanding the PSoC silicon is by reading this data sheet and using the PSoC Designer Integrated Development Environment (IDE). This data sheet is an overview of the PSoC integrated circuit and presents specific pin, register, and electrical specifications. For in-depth information, along with detailed programming information, reference the PSoC<sup>TM</sup> Mixed Signal Array Technical Reference Manual.

For up-to-date Ordering, Packaging, and Electrical Specification information, reference the latest PSoC device data sheets on the web at http://www.cypress.com/psoc.

### **Development Kits**

Development Kits are available from the following distributors: Digi-Key, Avnet, Arrow, and Future. The Cypress Online Store at http://www.onfulfillment.com/cypressstore/ contains development kits, C compilers, and all accessories for PSoC development. Click on *PSoC (Programmable System-on-Chip)* to view a current list of available items.

### Tele-Training

Free PSoC "Tele-training" is available for beginners and taught by a live marketing or application engineer over the phone. Five training classes are available to accelerate the learning curve including introduction, designing, debugging, advanced design, advanced analog, as well as application-specific classes covering topics like PSoC and the LIN bus. For days and times of the tele-training, see http://www.cypress.com/support/training.cfm.

### Consultants

Certified PSoC Consultants offer everything from technical assistance to completed PSoC designs. To contact or become a PSoC Consultant, go to the following Cypress support web site: http://www.cypress.com/support/cypros.cfm.

### **Technical Support**

PSoC application engineers take pride in fast and accurate response. They can be reached with a 4-hour guaranteed response at http://www.cypress.com/support/login.cfm.

### Application Notes

A long list of application notes will assist you in every aspect of your design effort. To locate the PSoC application notes, go to http://www.cypress.com/design/results.cfm.

# **Development Tools**

The Cypress MicroSystems PSoC Designer is a Microsoft<sup>®</sup> Windows-based, integrated development environment for the Programmable System-on-Chip (PSoC) devices. The PSoC Designer IDE and application runs on Windows 98, Windows NT 4.0, Windows 2000, Windows Millennium (Me), or Windows XP. (Reference the PSoC Designer Functional Flow diagram below.)

PSoC Designer helps the customer to select an operating configuration for the PSoC, write application code that uses the PSoC, and debug the application. This system provides design database management by project, an integrated debugger with In-Circuit Emulator, in-system programming support, and the CYASM macro assembler for the CPUs.

PSoC Designer also supports a high-level C language compiler developed specifically for the devices in the family.



**PSoC Designer Subsystems** 

### PSoC Designer Software Subsystems

#### Device Editor

The Device Editor subsystem allows the user to select different onboard analog and digital components called user modules using the PSoC blocks. Examples of user modules are ADCs, DACs, Amplifiers, and Filters.

The device editor also supports easy development of multiple configurations and dynamic reconfiguration. Dynamic configuration allows for changing configurations at run time.

PSoC Designer sets up power-on initialization tables for selected PSoC block configurations and creates source code for an application framework. The framework contains software to operate the selected components and, if the project uses more than one operating configuration, contains routines to switch between different sets of PSoC block configurations at run time. PSoC Designer can print out a configuration sheet for a given project configuration for use during application programming in conjunction with the Device Data Sheet. Once the framework is generated, the user can add application-specific code to flesh out the framework. It's also possible to change the selected components and regenerate the framework.

#### Design Browser

The Design Browser allows users to select and import preconfigured designs into the user's project. Users can easily browse a catalog of preconfigured designs to facilitate time-to-design. Examples provided in the tools include a 300-baud modem, LIN Bus master and slave, fan controller, and magnetic card reader.

### Application Editor

In the Application Editor you can edit your C language and Assembly language source code. You can also assemble, compile, link, and build.

**Assembler.** The macro assembler allows the assembly code to be merged seamlessly with C code. The link libraries automatically use absolute addressing or can be compiled in relative mode, and linked with other software modules to get absolute addressing.

**C Language Compiler.** A C language compiler is available that supports Cypress MicroSystems' PSoC family devices. Even if you have never worked in the C language before, the product quickly allows you to create complete C programs for the PSoC family devices.

The embedded, optimizing C compiler provides all the features of C tailored to the PSoC architecture. It comes complete with embedded libraries providing port and bus operations, standard keypad and display support, and extended math functionality.

### Debugger

The PSoC Designer Debugger subsystem provides hardware in-circuit emulation, allowing the designer to test the program in a physical system while providing an internal view of the PSoC device. Debugger commands allow the designer to read and program and read and write data memory, read and write IO registers, read and write CPU registers, set and clear breakpoints, and provide program run, halt, and step control. The debugger also allows the designer to create a trace buffer of registers and memory locations of interest.

### Online Help System

The online help system displays online, context-sensitive help for the user. Designed for procedural and quick reference, each functional subsystem has its own context-sensitive help. This system also provides tutorials and links to FAQs and an Online Support Forum to aid the designer in getting started.

### Hardware Tools

### In-Circuit Emulator

A low cost, high functionality ICE (In-Circuit Emulator) is available for development support. This hardware has the capability to program single devices.

The emulator consists of a base unit that connects to the PC by way of the parallel or USB port. The base unit is universal and will operate with all PSoC devices. Emulation pods for each device family are available separately. The emulation pod takes the place of the PSoC device in the target board and performs full speed (24 MHz) operation.



**PSoC Development Tool Kit** 

# 2. Register Reference



This chapter lists the registers of the CY8C22x13 PSoC device by way of mapping tables, in offset order. For detailed register information, reference the PSoC<sup>™</sup> Mixed Signal Array Technical Reference Manual.

# 2.1 Register Conventions

### 2.1.1 Abbreviations Used

The register conventions specific to this section are listed in the following table.

Convention	Description
RW	Read and write register or bit(s)
R	Read register or bit(s)
W	Write register or bit(s)
L	Logical register or bit(s)
С	Clearable register or bit(s)
#	Access is bit specific

# 2.2 Register Mapping Tables

The PSoC device has a total register address space of 512 bytes. The register space is also referred to as IO space and is broken into two parts. The XOI bit in the Flag register determines which bank the user is currently in. When the XOI bit is set, the user is said to be in the "extended" address space or the "configuration" registers.

**Note** In the following register mapping tables, blank fields are Reserved and should not be accessed.

# 3. Electrical Specifications



This chapter presents the DC and AC electrical specifications of the CY8C22x13 PSoC device. For the most up to date electrical specifications, confirm that you have the most recent data sheet by referencing the web at http://www.cypress.com/psoc.

Specifications are valid for  $-40^{\circ}C \le T_A \le 85^{\circ}C$  and  $T_J \le 100^{\circ}C$  as specified, except where noted. Specifications for devices running at greater than 12 MHz are valid for  $-40^{\circ}C \le T_A \le 70^{\circ}C$  and  $T_J \le 82^{\circ}C$ .



Figure 3-1. Voltage versus Operating Frequency

The following table lists the units of measure that are used in this chapter.

#### Table 3-1: Units of Measure

Symbol	Unit of Measure	Symbol	Unit of Measure
°C	degree Celsius	μW	micro watts
dB	decibels	mA	milli-ampere
fF	femto farad	ms	milli-second
Hz	hertz	mV	milli-volts
KB	1024 bytes	nA	nano ampere
Kbit	1024 bits	ns	nanosecond
kHz	kilohertz	nV	nanovolts
kΩ	kilohm	Ω	ohm
MHz	megahertz	pА	pico ampere
MΩ	megaohm	pF	pico farad
μΑ	micro ampere	рр	peak-to-peak
μF	micro farad	ppm	parts per million
μH	micro henry	ps	picosecond
μs	microsecond	sps	samples per second
μV	micro volts	σ	sigma: one standard deviation
μVrms	micro volts root-mean-square	V	volts

# 3.1 Absolute Maximum Ratings

Table 3-2. Absolute Maximum Ratings

Symbol	Description	Min	Тур	Max	Units	Notes
T <sub>STG</sub>	Storage Temperature	-55	-	+100	°C	Higher storage temperatures will reduce data retention time.
T <sub>A</sub>	Ambient Temperature with Power Applied	-40	-	+85	°C	
Vdd	Supply Voltage on Vdd Relative to Vss	-0.5	-	+6.0	V	
V <sub>IO</sub>	DC Input Voltage	Vss - 0.5	-	Vdd + 0.5	V	
-	DC Voltage Applied to Tri-state	Vss - 0.5	-	Vdd + 0.5	V	
I <sub>MIO</sub>	Maximum Current into any Port Pin	-25	-	+50	mA	
I <sub>MAIO</sub>	Maximum Current into any Port Pin Configured as Analog Driver	-50	-	+50	mA	
-	Static Discharge Voltage	2000	-	-	V	
-	Latch-up Current	-	-	200	mA	

# 3.2 Operating Temperature

### Table 3-3. Operating Temperature

Symbol	Description	Min	Тур	Max	Units	Notes
T <sub>A</sub>	Ambient Temperature	-40	-	+85	°C	
TJ	Junction Temperature	-40	-	+100	°C	The temperature rise from ambient to junction is package specific. See "Thermal Impedances" on page 34. The user must limit the power consumption to comply with this requirement.

### 3.3.3 DC Operational Amplifier Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, or 3.0V to 3.6V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, respectively. Typical parameters apply to 5V and 3.3V at 25°C and are for design guidance only or unless otherwise specified.

The Operational Amplifier is a component of both the Analog Continuous Time PSoC blocks and the Analog Switched Cap PSoC blocks. The guaranteed specifications are measured in the Analog Continuous Time PSoC block. Typical parameters apply to 5V at 25°C and are for design guidance only.

Symbol	Description	Min	Тур	Max	Units	Notes
V <sub>OSOA</sub>	Input Offset Voltage (absolute value) Low Power	-	1.6	10	mV	
	Input Offset Voltage (absolute value) Mid Power	-	1.3	8	mV	
	Input Offset Voltage (absolute value) High Power	-	1.2	7.5	mV	
TCV <sub>OSOA</sub>	Average Input Offset Voltage Drift	-	7.0	35.0	μV/ºC	
I <sub>EBOA</sub>	Input Leakage Current (Port 0 Analog Pins)	-	20	-	pА	Gross tested to 1 µA.
CINOA	Input Capacitance (Port 0 Analog Pins)	-	4.5	9.5	pF	Package and pin dependent. Temp = 25°C.
V <sub>CMOA</sub>	Common Mode Voltage Range Common Mode Voltage Range (high power or high opamp bias)	0.0 0.5	-	Vdd Vdd - 0.5	V	The common-mode input voltage range is mea- sured through an analog output buffer. The specification includes the limitations imposed by the characteristics of the analog output buffer.
G <sub>OLOA</sub>	Open Loop Gain Power = Low Power = Medium Power = High	60 60 80	-	-	dB	Specification is applicable at high power. For all other bias modes (except high power, high opamp bias), minimum is 60 dB.
V <sub>OHIGHOA</sub>	High Output Voltage Swing (worst case internal load) Power = Low Power = Medium	Vdd - 0.2 Vdd - 0.2	-	-	v v	
V <sub>OLOWOA</sub>	Power = High Low Output Voltage Swing (worst case internal load) Power = Low Power = Medium Power = High	Vdd - 0.5 - - -	- - -	- 0.2 0.2 0.5	V V V V	
I <sub>SOA</sub>	Supply Current (including associated AGND buffer) Power = Low Power = Low, Opamp Bias = High Power = Medium Power = Medium, Opamp Bias = High Power = High Power = High, Opamp Bias = High	- - - -	150 300 600 1200 2400 4600	200 400 800 1600 3200 6400	μΑ μΑ μΑ μΑ μΑ μΑ	
PSRR <sub>OA</sub>	Supply Voltage Rejection Ratio	60	-	-	dB	

Table 3-6. 5V DC Operational Amplifier Specifications

Table 3-7. 3.3V DC Operational Amplifier	Specifications
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Symbol	Description	Min	Тур	Max	Units	Notes
V <sub>OSOA</sub>	Input Offset Voltage (absolute value) Low Power	-	1.65	10	mV	
	Input Offset Voltage (absolute value) Mid Power	-	1.32	8	mV	
	High Power is 5 Volt Only					
TCV <sub>OSOA</sub>	Average Input Offset Voltage Drift	-	7.0	35.0	μV/ <sup>o</sup> C	
I <sub>EBOA</sub>	Input Leakage Current (Port 0 Analog Pins)	-	20	-	pА	Gross tested to 1 µA.
C <sub>INOA</sub>	Input Capacitance (Port 0 Analog Pins)	-	4.5	9.5	pF	Package and pin dependent. Temp = 25°C.
V <sub>CMOA</sub>	Common Mode Voltage Range	0.2	_	Vdd - 0.2	V	The common-mode input voltage range is measured through an analog output buffer. The specification includes the limitations imposed by the characteristics of the analog output buffer.
G <sub>OLOA</sub>	Open Loop Gain		-	-	dB	Specification is applicable at high power. For
	Power = Low	60				all other bias modes (except high power, high opamp bias), minimum is 60 dB.
	Power = Medium	60				
	Power = High	80				
V <sub>OHIGHOA</sub>	High Output Voltage Swing (worst case internal load)					
	Power = Low	Vdd - 0.2	-	-	V	
	Power = Medium	Vdd - 0.2	-	-	V	
	Power = High is 5V only	Vdd - 0.2	-	-	V	
V <sub>OLOWOA</sub>	Low Output Voltage Swing (worst case internal load)					
	Power = Low	-	-	0.2	V	
	Power = Medium	-	-	0.2	V	
	Power = High	-	-	0.2	V	
I <sub>SOA</sub>	Supply Current (including associated AGND buffer)					
	Power = Low	-	150	200	μΑ	
	Power = Low, Opamp Bias = High	-	300	400	μΑ	
	Power = Medium	-	600	800	μΑ	
	Power = Medium, Opamp Bias = High	-	1200	1600	μΑ	
	Power = High	-	2400	3200	μΑ	
	Power = High, Opamp Bias = High	-	4600	6400	μΑ	
PSRR <sub>OA</sub>	Supply Voltage Rejection Ratio	50	-	-	dB	

### 3.3.5 DC Analog Reference Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, or 3.0V to 3.6V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, respectively. Typical parameters apply to 5V and 3.3V at 25°C and are for design guidance only or unless otherwise specified.

The guaranteed specifications are measured through the Analog Continuous Time PSoC blocks. The power levels for AGND refer to the power of the Analog Continuous Time PSoC block. The power levels for RefHi and RefLo refer to the Analog Reference Control register. The limits stated for AGND include the offset error of the AGND buffer local to the Analog Continuous Time PSoC block.

#### Table 3-10. 5V DC Analog Reference Specifications

Symbol	Description	Min	Тур	Max	Units
-	$AGND = Vdd/2^a$				
	CT Block Power = High	Vdd/2 - 0.043	Vdd/2 - 0.025	Vdd/2 + 0.003	V

a. AGND tolerance includes the offsets of the local buffer in the PSoC block. Bandgap voltage is 1.3V ± 2%.

#### Table 3-11. 3.3V DC Analog Reference Specifications

Symbol	Description	Min	Тур	Max	Units
-	AGND = Vdd/2 <sup>a</sup>				
	CT Block Power = High	Vdd/2 - 0.037	Vdd/2 - 0.020	Vdd/2 + 0.002	V

a. AGND tolerance includes the offsets of the local buffer in the PSoC block. Bandgap voltage is 1.3V  $\pm$  2%

### 3.3.6 DC Analog PSoC Block Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, or 3.0V to 3.6V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, respectively. Typical parameters apply to 5V and 3.3V at 25°C and are for design guidance only or unless otherwise specified.

#### Table 3-12. DC Analog PSoC Block Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
R <sub>CT</sub>	Resistor Unit Value (Continuous Time)	-	12.24	-	kΩ	
C <sub>SC</sub>	Capacitor Unit Value (Switch Cap)	-	80	-	fF	

### 3.3.8 DC Programming Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, or 3.0V to 3.6V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, respectively. Typical parameters apply to 5V and 3.3V at 25°C and are for design guidance only or unless otherwise specified.

#### Table 3-14. DC Programming Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
I <sub>DDP</sub>	Supply Current During Programming or Verify	-	5	25	mA	
V <sub>ILP</sub>	Input Low Voltage During Programming or Verify	-	-	0.8	V	
V <sub>IHP</sub>	Input High Voltage During Programming or Verify	2.2	-	-	V	
I <sub>ILP</sub>	Input Current when Applying Vilp to P1[0] or P1[1] During Programming or Verify	-	-	0.2	mA	Driving internal pull-down resistor.
I <sub>IHP</sub>	Input Current when Applying Vihp to P1[0] or P1[1] During Programming or Verify	-	-	1.5	mA	Driving internal pull-down resistor.
V <sub>OLV</sub>	Output Low Voltage During Programming or Verify	-	-	Vss + 0.75	V	
V <sub>OHV</sub>	Output High Voltage During Programming or Verify	Vdd - 1.0	-	Vdd	V	
Flash <sub>ENPB</sub>	Flash Endurance (per block)	50,000	-	-	-	Erase/write cycles per block.
Flash <sub>ENT</sub>	Flash Endurance (total) <sup>a</sup>	1,800,000	-	-	-	Erase/write cycles.
Flash <sub>DR</sub>	Flash Data Retention	10	-	-	Years	

a. A maximum of 36 x 50,000 block endurance cycles is allowed. This may be balanced between operations on 36x1 blocks of 50,000 maximum cycles each, 36x2 blocks of 25,000 maximum cycles each, or 36x4 blocks of 12,500 maximum cycles each (and so forth to limit the total number of cycles to 36x50,000 and that no single block ever sees more than 50,000 cycles).

For the full industrial range, the user must employ a temperature sensor user module (FlashTemp) and feed the result to the temperature argument before writing. Refer to the Flash APIs Application Note AN2015 at http://www.cypress.com under Application Notes for more information.

# **3.4 AC Electrical Characteristics**

### 3.4.1 AC Chip-Level Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, or 3.0V to 3.6V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, respectively. Typical parameters apply to 5V and 3.3V at 25°C and are for design guidance only or unless otherwise specified.

Table 3-1	5. AC C	hip-Level	Specifications
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Symbol	Description	Min	Тур	Max	Units	Notes
F <sub>IMO</sub>	Internal Main Oscillator Frequency	23.4	24	24.6 <sup>a</sup>	MHz	Trimmed. Utilizing factory trim values.
F <sub>CPU1</sub>	CPU Frequency (5V Nominal)	0.93	24	24.6 <sup>a,b</sup>	MHz	
F <sub>CPU2</sub>	CPU Frequency (3.3V Nominal)	0.93	12	12.3 <sup>b,c</sup>	MHz	
F <sub>48M</sub>	Digital PSoC Block Frequency	0	48	49.2 <sup>a,b,d</sup>	MHz	Refer to the AC Digital Block Specifications below.
F <sub>24M</sub>	Digital PSoC Block Frequency	0	24	24.6 <sup>b,e,d</sup>	MHz	
F <sub>32K1</sub>	Internal Low Speed Oscillator Frequency	15	32	64	kHz	
F <sub>32K2</sub>	External Crystal Oscillator	-	32.768	-	kHz	Accuracy is capacitor and crystal dependent. 50% duty cycle.
F <sub>PLL</sub>	PLL Frequency	-	23.986	-	MHz	Is a multiple (x732) of crystal frequency.
Jitter24M2	24 MHz Period Jitter (PLL)	-	-	600	ps	
T <sub>PLLSLEW</sub>	PLL Lock Time	0.5	-	10	ms	
T <sub>PLLSLEWS</sub> - LOW	PLL Lock Time for Low Gain Setting	0.5	-	50	ms	
T <sub>OS</sub>	External Crystal Oscillator Startup to 1%	-	1700	2620	ms	
T <sub>OSACC</sub>	External Crystal Oscillator Startup to 100 ppm	-	2800	3800 <sup>f</sup>	ms	
Jitter32k	32 kHz Period Jitter	-	100		ns	
T <sub>XRST</sub>	External Reset Pulse Width	10	-	-	μs	
DC24M	24 MHz Duty Cycle	40	50	60	%	
Step24M	24 MHz Trim Step Size	-	50	-	kHz	
Fout48M	48 MHz Output Frequency	46.8	48.0	49.2 <sup>a,c</sup>	MHz	Trimmed. Utilizing factory trim values.
Jitter24M1	24 MHz Period Jitter (IMO)	-	600		ps	
F <sub>MAX</sub>	Maximum frequency of signal on row input or row output.	-	-	12.3	MHz	
T <sub>RAMP</sub>	Supply Ramp Time	0	-	-	μs	

a. 4.75V < Vdd < 5.25V.

b. Accuracy derived from Internal Main Oscillator with appropriate trim for Vdd range.

c. 3.0V < Vdd < 3.6V. See Application Note AN2012 "Adjusting PSoC Microcontroller Trims for Dual Voltage-Range Operation" for information on trimming for operation at 3.3V.

d. See the individual user module data sheets for information on maximum frequencies for user modules.

e. 3.0V < 5.25V.

f. The crystal oscillator frequency is within 100 ppm of its final value by the end of the  $T_{osacc}$  period. Correct operation assumes a properly loaded 1 uW maximum drive level 32.768 kHz crystal.  $3.0V \le Vdd \le 5.5V$ , -40 °C  $\le T_A \le 85$  °C.







Figure 3-3. PLL Lock for Low Gain Setting Timing Diagram



Figure 3-4. External Crystal Oscillator Startup Timing Diagram



Figure 3-5. 24 MHz Period Jitter (IMO) Timing Diagram



Figure 3-6. 32 kHz Period Jitter (ECO) Timing Diagram

### 3.4.2 AC General Purpose IO Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, or 3.0V to 3.6V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, respectively. Typical parameters apply to 5V and 3.3V at 25°C and are for design guidance only or unless otherwise specified.

#### Table 3-16. AC GPIO Specifications

Symbol	Description	Min	Тур	Max	Units	Notes
F <sub>GPIO</sub>	GPIO Operating Frequency	0	-	12	MHz	
TRiseF	Rise Time, Normal Strong Mode, Cload = 50 pF	3	-	18	ns	Vdd = 4.5 to 5.25V, 10% - 90%
TFallF	Fall Time, Normal Strong Mode, Cload = 50 pF	2	-	18	ns	Vdd = 4.5 to 5.25V, 10% - 90%
TRiseS	Rise Time, Slow Strong Mode, Cload = 50 pF	10	27	-	ns	Vdd = 3 to 5.25V, 10% - 90%
TFallS	Fall Time, Slow Strong Mode, Cload = 50 pF	10	22	-	ns	Vdd = 3 to 5.25V, 10% - 90%



Figure 3-7. GPIO Timing Diagram

Table 3-18. 3.3V	AC Or	perational An	plifier S	pecifications

Symbol	Description	Min	Тур	Max	Units	Notes
T <sub>ROA</sub>	Rising Settling Time from 80% of $\Delta V$ to 0.1% of $\Delta V$ (10 pF load, Unity Gain)					Specification maximums for low power and high opamp bias, medium power, and
	Power = Low	-	-	3.92	μs	medium power and high opamp bias levels
	Power = Low, Opamp Bias = High	-			μs	are between low and high power levels.
	Power = Medium	-			μs	
	Power = Medium, Opamp Bias = High	-	-	0.72	μs	
	Power = High (3.3 Volt High Bias Operation not supported)	-	-	-	μs	
	Power = High, Opamp Bias = High (3.3 Volt High Power, High Opamp Bias not supported)	-	_	-	μs	
T <sub>SOA</sub>	Falling Settling Time from 20% of $\Delta V$ to 0.1% of $\Delta V$ (10 pF load, Unity Gain)					Specification maximums for low power and high opamp bias, medium power, and
	Power = Low	-	-	5.41	μs	medium power and high opamp bias levels
	Power = Low, Opamp Bias = High	-			μs	are between low and high perior levele.
	Power = Medium	-			μs	
	Power = Medium, Opamp Bias = High	-	-	0.72	μs	
	Power = High (3.3 Volt High Bias Operation not supported)	-	-	-	μs	
	Power = High, Opamp Bias = High (3.3 Volt High Power, High Opamp Bias not supported)	_	_	_	μs	
SR <sub>ROA</sub>	Rising Slew Rate (20% to 80%)(10 pF load, Unity Gain)					Specification minimums for low power and
	Power = Low	0.31	-		V/µs	high opamp bias, medium power, and medium power and high opamp bias levels
	Power = Low, Opamp Bias = High				V/µs	are between low and high power levels.
	Power = Medium				V/µs	
	Power = Medium, Opamp Bias = High	2.7	-		V/µs	
	Power = High (3.3 Volt High Bias Operation not supported)	-	-	-	V/µs	
	Power = High, Opamp Bias = High (3.3 Volt High Power, High Opamp Bias not supported)	_	_	_	V/µs	
SR <sub>FOA</sub>	Falling Slew Rate (20% to 80%)(10 pF load, Unity Gain)					Specification minimums for low power and
	Power = Low	0.24	-		V/µs	high opamp bias, medium power, and medium power and high opamp bias levels
	Power = Low, Opamp Bias = High				V/µs	are between low and high power levels.
	Power = Medium				V/µs	
	Power = Medium, Opamp Bias = High	1.8	-		V/µs	
	Power = High (3.3 Volt High Bias Operation not supported)	-	-	-	V/µs	
	Power = High, Opamp Bias = High (3.3 Volt High Power, High Opamp Bias not supported)	_	_	_	V/µs	
BW <sub>OA</sub>	Gain Bandwidth Product					Specification minimums for low power and
	Power = Low	0.67	-		MHz	high opamp bias, medium power, and medium power and high opamp bias levels
	Power = Low, Opamp Bias = High				MHz	are between low and high power levels.
	Power = Medium				MHz	
	Power = Medium, Opamp Bias = High	2.8	-		MHz	
	Power = High (3.3 Volt High Bias Operation not supported)	-	-	-	MHz	
	Power = High, Opamp Bias = High (3.3 Volt High Power, High Opamp Bias not supported)	-	-	-	MHz	
E <sub>NOA</sub>	Noise at 1 kHz (Power = Medium, Opamp Bias = High)	-	200	-	nV/rt-Hz	

# 3.4.8 AC I<sup>2</sup>C Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75V to 5.25V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, or 3.0V to 3.6V and -40°C  $\leq$  T<sub>A</sub>  $\leq$  85°C, respectively. Typical parameters apply to 5V and 3.3V at 25°C and are for design guidance only or unless otherwise specified.

Table 3-25. AC Characteristics of the I<sup>2</sup>C SDA and SCL Pins

		Standa	rd Mode	Fast	Mode		
Symbol	Description	Min	Max	Min	Max	Units	Notes
F <sub>SCLI2C</sub>	SCL Clock Frequency	0	100	0	400	kHz	
T <sub>HDSTAI2C</sub>	Hold Time (repeated) START Condition. After this 4 period, the first clock pulse is generated.		-	0.6	-	μs	
T <sub>LOWI2C</sub>	LOW Period of the SCL Clock	4.7	-	1.3	-	μs	
T <sub>HIGHI2C</sub>	HIGH Period of the SCL Clock	4.0	-	0.6	-	μs	
T <sub>SUSTAI2C</sub>	Set-up Time for a Repeated START Condition		-	0.6	-	μs	
T <sub>HDDATI2C</sub>	Data Hold Time	0	-	0	-	μs	
T <sub>SUDATI2C</sub>	Data Set-up Time	250	-	100 <sup>a</sup>	-	ns	
T <sub>SUSTOI2C</sub>	Set-up Time for STOP Condition	4.0	-	0.6	-	μs	
T <sub>BUFI2C</sub>	Bus Free Time Between a STOP and START Condition	4.7	-	1.3	-	μs	
T <sub>SPI2C</sub>	Pulse Width of spikes are suppressed by the input fil- ter.	-	-	0	50	ns	

a. A Fast-Mode I2C-bus device can be used in a Standard-Mode I2C-bus system, but the requirement  $t_{SU;DAT} \ge 250$  ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line  $t_{rmax} + t_{SU;DAT} = 1000 + 250 = 1250$  ns (according to the Standard-Mode I2C-bus specification) before the SCL line is released.



Figure 3-8. Definition for Timing for Fast/Standard Mode on the I<sup>2</sup>C Bus















Figure 4-5. 20-Lead (300-Mil) Molded SOIC



DIMENSIONS IN mm MIN.



# 4.2 Thermal Impedances

Package	Typical $\theta_{JA}{}^{\star}$
8 PDIP	123 °C/W
8 SOIC	185 °C/W
20 PDIP	109 °C/W
20 SSOP	117 °C/W
20 SOIC	81 °C/W
32 MLF	22 °C/W

\* T<sub>J</sub> = T<sub>A</sub> + POWER x  $\theta_{JA}$ 

# 4.3 Capacitance on Crystal Pins

Table 4-2:	Typical Package	Capacitance or	n Crystal Pins
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Package	Package Capacitance
8 PDIP	2.8 pF
8 SOIC	2.0 pF
20 PDIP	3.0 pF
20 SSOP	2.6 pF
20 SOIC	2.5 pF
32 MLF	2.0 pF



The following table lists the CY8C22x13 PSoC Device family's key package features and ordering codes.

Package	Ordering Code	Flash (Kbytes)	RAM (Bytes)	Switch Mode Pump	Temperature Range	Digital Blocks (Rows of 4)	Analog Blocks (Columns of 3)	Digital IO Pins	Analog Inputs	Analog Outputs	XRES Pin
8 Pin (300 Mil) DIP	CY8C22113-24PI	2	256	No	-40C to +85C	4	3	6	4	1	No
8 Pin (150 Mil) SOIC	CY8C22113-24SI	2	256	No	-40C to +85C	4	3	6	4	1	No
8 Pin (150 Mil) SOIC (Tape and Reel)	CY8C22113-24SIT	2	256	No	-40C to +85C	4	3	6	4	1	No
20 Pin (300 Mil) DIP	CY8C22213-24PI	2	256	No	-40C to +85C	4	3	16	8	1	Yes
20 Pin (210 Mil) SSOP	CY8C22213-24PVI	2	256	No	-40C to +85C	4	3	16	8	1	Yes
20 Pin (210 Mil) SSOP (Tape and Reel)	CY8C22213-24PVIT	2	256	No	-40C to +85C	4	3	16	8	1	Yes
20 Pin (300 Mil) SOIC	CY8C22213-24SI	2	256	No	-40C to +85C	4	3	16	8	1	Yes
20 Pin (300 Mil) SOIC (Tape and Reel)	CY8C22213-24SIT	2	256	No	-40C to +85C	4	3	16	8	1	Yes
32 Pin (5x5 mm) MLF	CY8C22213-24LFI	2	256	No	-40C to +85C	4	3	16	8	1	Yes

Table 5-1. CY8C22x13 PSoC Device Family Key Features and Ordering Information

# 5.1 Ordering Code Definitions



# 6. Sales and Company Information



To obtain information about Cypress MicroSystems or PSoC sales and technical support, reference the following information or go to the section titled "Getting Started" on page 4 in this document.

#### **Cypress MicroSystems**

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## 6.1 Revision History

#### Table 6-1. CY8C22x13 Data Sheet Revision History

Document Title: CY8C22113 and CY8C22213 PSoC Mixed Signal Array Final Data Sheet						
Document NU	imber: 38-12	:009				
Revision	ECN #	Issue Date	Origin of Change	Description of Change		
**	128180	06/30/2003	New Silicon.	New document – Advanced Data Sheet (two page product brief).		
*A	129202	09/16/2003	NWJ	New document – Preliminary Data Sheet (300 page product detail).		
*В	130127	10/15/2003	NWJ	Revised document for Silicon Revision A.		
*C	131679	12/05/2003	NWJ	Changes to Electrical Specifications section, Miscellaneous changes to I2C, GDI, RDI, Registers, and Digital Block chapters.		
*D	131803	12/22/2003	NWJ	Changes to Electrical Specifications and miscellaneous small changes throughout the data sheet.		
*E	229421	06/03/2004	SFV	New data sheet format and organization. Reference the PSoC Mixed Signal Array Tech- nical Reference Manual for additional information. Title change.		
Distribution:	Distribution: External/Public Posting: None					

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